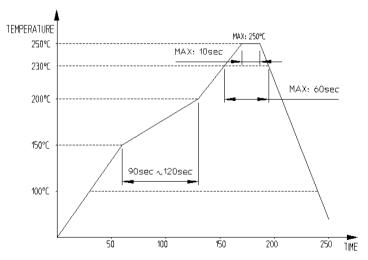
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REV	COUNT	DESCF	RIPTION OF REV	ISIONS	BY	CHKD	DATE	REV	COUN	T DI	DESCR	IPTION OF RE	/ISIONS	BY	CHKD	DA	ΤE
<u> </u>	_	- Revised BJH LHJ 19.06.12 3 - Revised KYG			KYG	LHJ	21.0	8.23									
- RE-2-1343 (Released) PMC LHJ				19.09.30	4	_	Re	Revised	evised KYI LH					21.12.16			
,	APPLICABLE STANDARD Universal Serial Bus Type-C Cable and Connector Specification Release 2.1 Universal Serial Bus Type-C Connectors and Cable Assemblies Compliance Document Revision 2.1b																
RATING CURRENT 0.25A for the other					ch power pin (A1, A4, A9, A12, B1, B4, B5, B9, B12) r pins												
VOLTAGE 48V AC/DC OPERATING CONDITION -40° ~ +105° (IN						NCLUDING TEMP. RISE), 95% RH max. (NON-CONDENSING)											
STORAGE CONDITION -10° ~ +60° (WITH PACKING), 15% ~ 70% RH																	
Para.	T	est Des	scription	•		Test I	Procedi	ıre				Test Requirement					ΑТ
1	1 Examination of product EIA 364-18 Visual inspection									No ;	No physical damage.						
Electi	rical R	equirer	nents														
2	Lo	Low Level Contact Resistance Resistance EIA 364–23 Measure at 20mV max ope at 100mA max. (DC or 100 4–wire measurement is req the resistance of PCB term shall be deducted from the					r 1000Hz s required terminati) d and on			Initial : 40mΩ max After test : 50mΩ max					0	ı
3	Wit	Diele hstandi	ectric ng Voltage	Measur unmate	EIA 364-20 Measure per Method B with Inmated condition. OOV AC RMS for 1 minute at sea level.					No d	lo disruptive discharge.					ı	
4	Insi	ulation I	Resistance	EIA 36- 500V D		ınmated	d and ma	ted cor	ndition.		100	100MΩ min. O					ı
Mech	anical	Requi	rements														
5		Insertio	n force	EIA 36 Measur		5mm/m	ninute mi	n.				nitial & After test : 5N ~ 20N with virgin plug)					-
6	E	Extraction	on force	EIA 36- Measur		5mm/m	inute mi				ial: 8N ~ 20N er test: 6N ~ 20N (with virgin plug)				0	-	
7		Dura	bility	EIA 364-09 Mated 10,000 times Mechanically operated: 500cycles/hr Mating stroke: 2.75mm Insertion, extraction force shall be measured at a maximum speed of 12.5mm/min						0	ı						
8	R	andom	Vibration	EIA 364-28 Test Condition VII, Test Letter D Mated specimens to 3.10 G's RMS between 20 to 500Hz 15 minutes in each of 3 mutually perpendicular planes. No physical damage. No discontinuity of 1µs of longer duration when mated connector during test.					0	1							
REMAR	RKS						DRA	AFT .	DE	SIG	NE NE	N CHECK APPI		OVAL	REL	EAS	E
					S.H.			H.LI					21.1	EPT 2.16			
						19.0	3.20	19.	03.	.20 19.03.20 19.03.20				EI	VG		
NOTE) QT: QUALIFICATION TEST, AT: ASSURANCE TEST, O: Applicable Test																	
DWG N	ELC4-632698 CL NO				6240-0024-4 CX90B-16P					SP							
ĸ	HIS HIROSE KOREA.CO.,LTD				PRODUCT SPECIFICATION 1/3								3				

Para.	Test Description	Test Procedure	Test Requirement	QT	ΑТ			
Environmental Requirements								
9	Temperature Life	EIA 364-17, Method A 105℃ without applied voltage for 120 hours.	No physical damage.	0	_			
10	Cyclic Temperature and Humidity	EIA 364-31 25±3°C at 80±3% RH for 1 hour. 65±3°C at 50±3% RH for 1 hour. Thermal ramp: 0.5 hour Number of cycles: 24 cycles	No physical damage.	0	_			
11	Thermal Shock	EIA 364-32, Test Condition I 10 cycles -55°C and +105°C	No physical damage.	0	_			
12	Solderability	EIA 364-52 Dwell in 245±5℃ of the solder bath for 5 sec.	Solder coverage shall be 95% min. of the immersed surfaces.	0	_			
13	Salt Spray	EIA 364-26 5% of NaCl in 35℃ for 48 hours.	No corrosions that affect to the connector operation.	0	_			
14	Co-planarity	Measure co-planarity of each contact lead.	Co-planarity shall be 0.08 max. before & after reflow 2 times.	0	_			
15	Reflow test	Reflow profile [Fig.1] Peak 250°C max for 10 sec 2 times.	No deformation of mold No shape of blister and popcorn	0	_			

REMARKS



[Fig.1] REFLOW TEMPERATURE

NOTE) QT: QUALIFICATION TEST, AT: ASSURANCE TEST, O: Applicable Test								
DWG NO CL NO PART NO								
ELC4-632698	CL 6240-0024-4	CX90B-16P						

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PRODUCT SPECIFICATION

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Qualification Test Sequence Table												
Dava	Took Doorwinking	Test Group										
Para.	Test Description	Α	В	С	D	Е	F	G	Н			
1	Examination of product	1, 6	1, 14	1, 6	1, 6	1, 6	1, 3	1, 6	1, 4			
2	Low Level Contact Resistance	3, 5	3, 13	3, 5	3, 5	3, 5		3, 5				
3	Dielectric Withstanding Voltage		4, 12									
4	Insulation Resistance		5, 11									
5	Insertion force		6, 10									
6	Extraction force		7, 9									
7	Durability		8									
8	Random Vibration	4										
9	Temperature Life			4								
10	Cyclic Temperature and Humidity				4							
11	Thermal Shock					4						
12	Solderability						2					
13	Salt Spray							4				
14	Co-planarity								3			
15	Reflow Test	2	2	2	2	2		2	2			

REMARKS

1) Numbers in the table above indicate the sequence corresponding to each test group.

NOTE) QT : QUALIFICATION TEST, AT : ASSURANCE TEST, 0 : Applicable Test

DWG NO

ELC4-632698

CL NO

CL 6240-0024-4

CX90B-16P

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PRODUCT SPECIFICATION